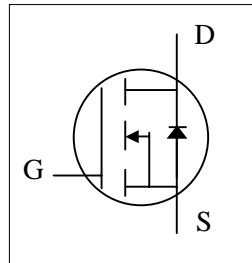




- Simple Drive Requirement**
- Isolation Full Package**
- Fast Switching Characteristics**
- RoHS compliant**

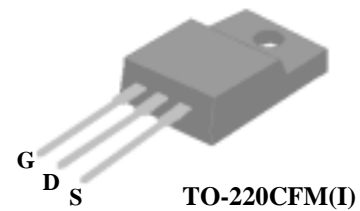


BV_{DSS}	750V
$R_{DS(ON)}$	1.45
I_D	8.0A

Description

AP2763 series are specially designed as main switching devices for universal 90~265VAC off-line AC/DC converter applications.

TO-220CFM type provide high blocking voltage to overcome voltage surge and sag in the toughest power system with the best combination of fast switching, ruggedized design and cost-effectiveness.



TO-220CFM(I)

Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	750	V
V_{GS}	Gate-Source Voltage	±30	V
$I_D@T_C=25$	Continuous Drain Current, V_{GS} @ 10V	8.0	A
$I_D@T_C=100$	Continuous Drain Current, V_{GS} @ 10V	5.0	A
I_{DM}	Pulsed Drain Current ¹	30	A
$P_D@T_C=25$	Total Power Dissipation	50	W
	Linear Derating Factor	0.4	W/
E_{AS}	Single Pulse Avalanche Energy ²	100	mJ
I_{AR}	Avalanche Current	8.0	A
T_{STG}	Storage Temperature Range	-55 to 150	
T_J	Operating Junction Temperature Range	-55 to 150	

Thermal Data

Symbol	Parameter	Value	Units
Rthj-c	Thermal Resistance Junction-case	Max. 2.5	/W
Rthj-a	Thermal Resistance Junction-ambient	Max. 62	/W



AP2763I-A

Electrical Characteristics @T_j=25°C(unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =1mA	750	-	-	V
BV _{DSS} / T _j	Breakdown Voltage Temperature Coefficient	Reference to 25 °C, I _D =1mA	-	0.7	-	V/°C
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =10V, I _D =4.0A	-	-	1.45	Ω
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250uA	2	-	4	V
g _{fs}	Forward Transconductance	V _{DS} =10V, I _D =4.0A	-	3.6	-	S
I _{DSS}	Drain-Source Leakage Current (T _j =25°C)	V _{DS} =750V, V _{GS} =0V	-	-	10	uA
	Drain-Source Leakage Current (T _j =125°C)	V _{DS} =600V, V _{GS} =0V	-	-	100	uA
I _{GSS}	Gate-Source Leakage	V _{GS} =±30V	-	-	±100	nA
Q _g	Total Gate Charge ³	I _D =4.5A	-	47	75	nC
Q _{gs}	Gate-Source Charge	V _{DS} =600V	-	9	-	nC
Q _{gd}	Gate-Drain ("Miller") Charge	V _{GS} =10V	-	21	-	nC
t _{d(on)}	Turn-on Delay Time ³	V _{DD} =360V	-	15	-	ns
t _r	Rise Time	I _D =4.5A	-	14	-	ns
t _{d(off)}	Turn-off Delay Time	R _G =10 Ω, V _{GS} =10V	-	70	-	ns
t _f	Fall Time	R _D =80 Ω	-	20	-	ns
C _{iss}	Input Capacitance	V _{GS} =0V	-	1830	2930	pF
C _{oss}	Output Capacitance	V _{DS} =25V	-	150	-	pF
C _{rss}	Reverse Transfer Capacitance	f=1.0MHz	-	23	-	pF
R _g	Gate Resistance	f=1.0MHz	-	2.4	3.6	Ω

Source-Drain Diode

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
V _{SD}	Forward On Voltage ³	I _S =8.0A, V _{GS} =0V	-	-	1.5	V
t _{rr}	Reverse Recovery Time	I _S =4.5A, V _{GS} =0V,	-	580	-	ns
Q _{rr}	Reverse Recovery Charge	dI/dt=100A/μs	-	5.3	-	μC

Notes:

- 1.Pulse width limited by safe operating area.
- 2.Starting T_j=25°C, V_{DD}=50V, R_G=25 Ω, I_{AS}=8.0A.
- 3.Pulse width ≤300us, duty cycle ≤2%.

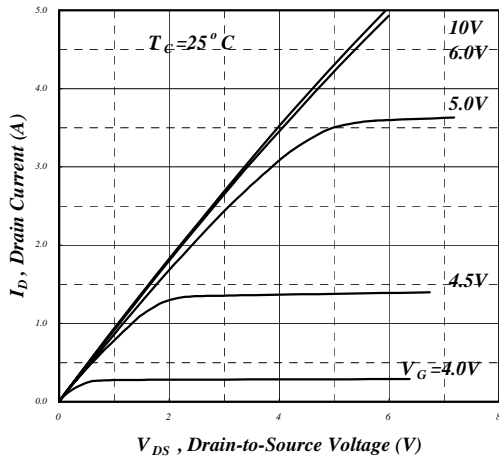


Fig 1. Typical Output Characteristics

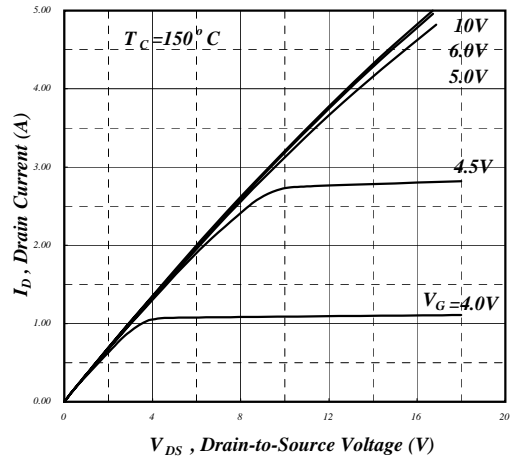


Fig 2. Typical Output Characteristics

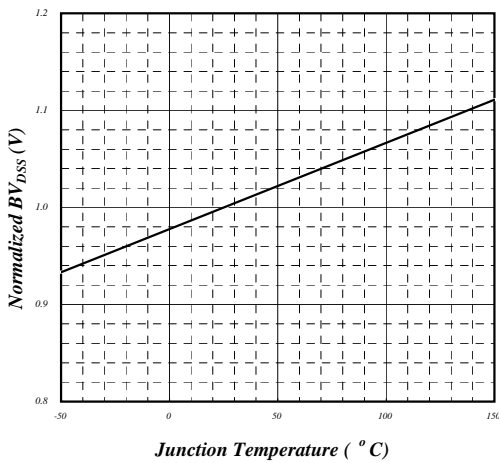


Fig 3. Normalized BV_{DSS} v.s. Junction Temperature

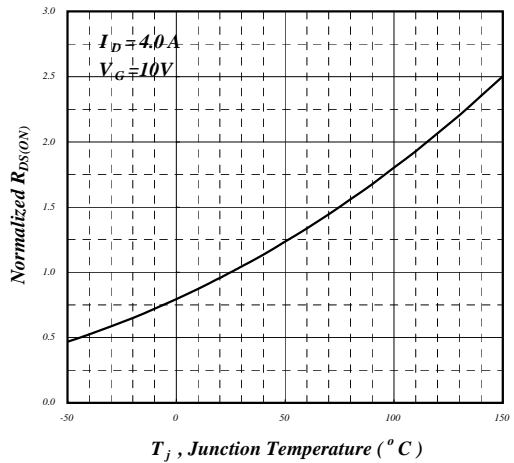


Fig 4. Normalized On-Resistance v.s. Junction Temperature

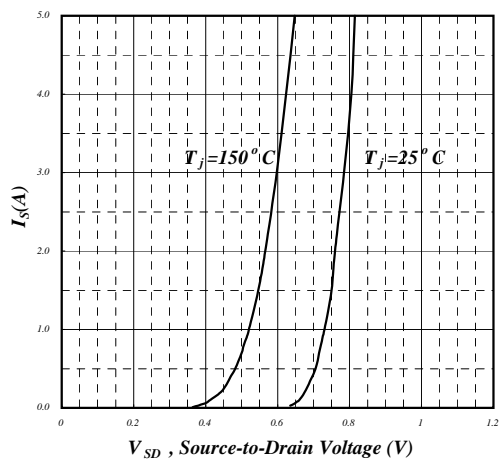


Fig 5. Forward Characteristic of Reverse Diode

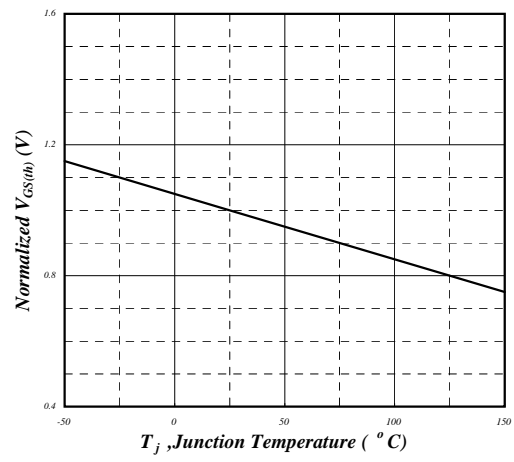


Fig 6. Gate Threshold Voltage v.s. Junction Temperature

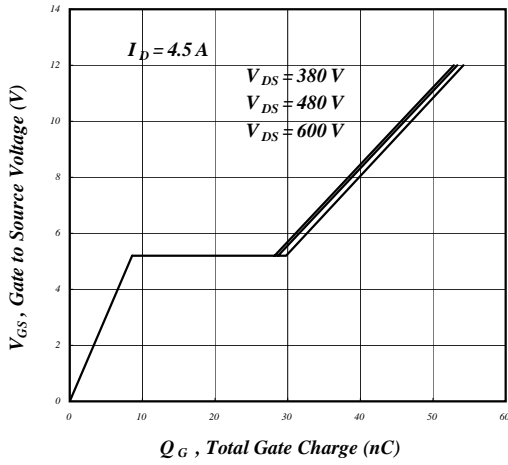


Fig 7. Gate Charge Characteristics

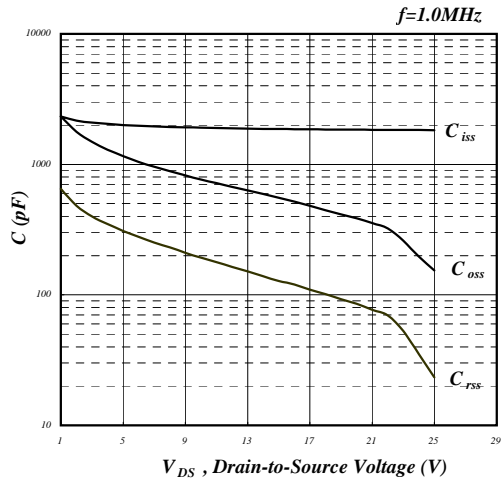


Fig 8. Typical Capacitance Characteristics

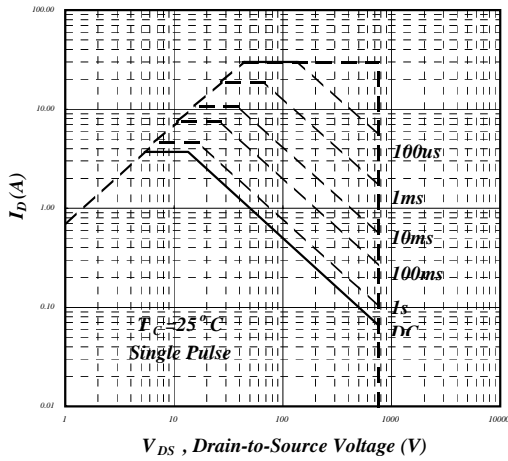


Fig 9. Maximum Safe Operating Area

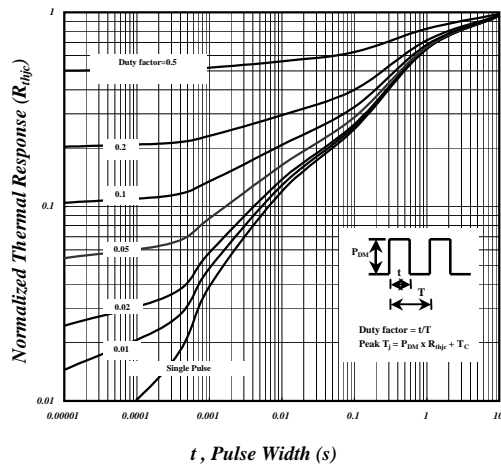


Fig 10. Effective Transient Thermal Impedance

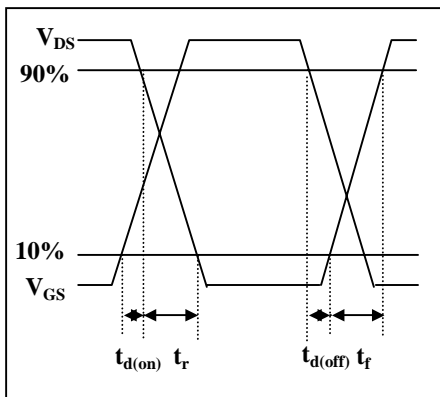


Fig 11. Switching Time Waveform

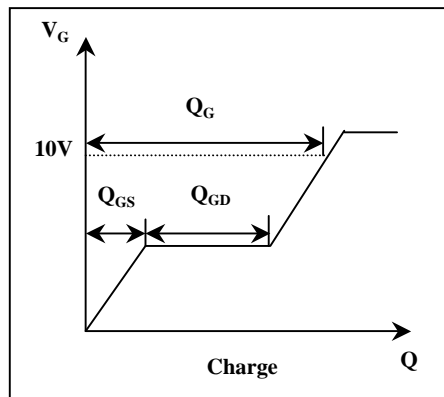


Fig 12. Gate Charge Waveform